



**THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Chuen Rong Leu et al.  
Assignee: Bridge Semiconductor Corporation  
Title: SEMICONDUCTOR CHIP ASSEMBLY WITH EMBEDDED METAL PILLAR  
Serial No.: 10/714,794 Filed: November 17, 2003  
Examiner: Unknown Group Art Unit: Unknown  
Atty. Docket No.: BDG024

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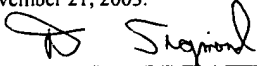
**INFORMATION DISCLOSURE STATEMENT**

Pursuant to Applicant's duty of disclosure under 37 C.F.R. § 1.56 and §§ 1.97-1.98, Applicant hereby provides a copy of the documents identified on the enclosed Form PTO-1449.

The filing of this Information Disclosure Statement shall not be construed as a representation that a search has been made, an admission that any of these documents, alone or in any combination, is considered to be material to patentability, an admission that any of these documents is prior art as to the above-identified application, or an admission against interest in any manner.

This Information Disclosure Statement is filed before the mailing date of a first Office Action on the merits. Accordingly, no fee is due. 37 C.F.R. § 1.97(b)(3).

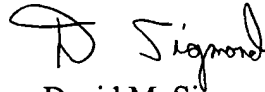
I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as First Class Mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on November 21, 2003.



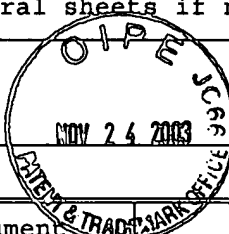
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11, 21, 03  
Date of Signature

Respectfully submitted,



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Form PTO-1449 U.S. Department of Commerce, Patent and Trademark Office				Atty Docket No. BDG024		Serial No. 10/714,794		
<b>INFORMATION DISCLOSURE STATEMENT</b> (Use several sheets if necessary)				Applicant Chuen Rong Leu et al.				
				Filing Date November 17, 2003		Group Art Unit		
<b>U.S. Patent Documents</b>								
*Examiner Initial		Document Number	Date	Name	Class	Subclass	Filing Date If Appropriate	
	AA	5,973,393	10/26/99	Chia et al.	257	690		
	AB	6,001,671	12/14/99	Fjelstad	438	112		
	AC	6,025,650	02/15/00	Tsuji et al.	257	786		
	AD	6,180,881	01/30/01	Isaak	174	52.4		
	AE	6,188,127	02/13/01	Senba et al.	257	686		
	AF	6,218,728	04/17/01	Kimura	257	693		
	AG	6,303,997	10/16/01	Lee	257	778		
	AH	6,483,718	11/19/02	Hashimoto	361	803		
	AI	6,504,241	01/07/03	Yanagida	257	686		
	AJ	6,608,371	08/19/03	Kurashima et al.	257	686		
	AK							
	AL							
	AM							
<b>Foreign Patent Documents</b>								
							Translation	
		Document	Date	Country	Class	Subclass	Yes	No
	AN							
	AO							
<b>Other Art (Including Author, Title, Date, Pertinent Pages, Etc.)</b>								
	AP							
	AQ							
Examiner			Date Considered					
<b>*EXAMINER:</b> Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with your next communication to Applicant.								